

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SURFACE MOUNT DISPLAY

Part Number: ACPSA04-41SGWA

Super Bright Green

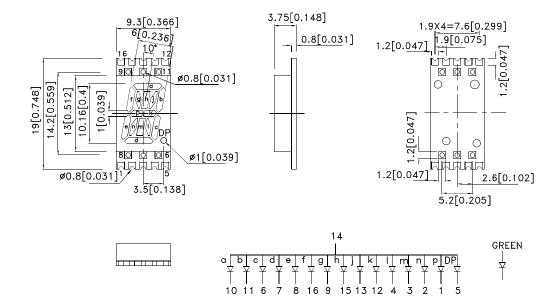
Features

- 0.4 inch character height.
- Low current operation.
- High contrast and light output.
- Categorized for luminous intensity.
- Mechanically rugged.
- Gray face, white segment.
- Package: 400pcs / reel.
- Moisture sensitivity level : level 2a.
- RoHS compliant.

Description

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram







- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 3. The gap between the reflector and PCB shall not exceed 0.25mm.

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Selection Guide

Part No.	Dice	Lens Type	lv (ucd) [1] @ 10mA		Description
			Min.	Тур.	
ACPSA04-41SGWA	Super Bright Green (GaP)	White Diffused	1400	2900	Common Anode, Rt. Hand Decimal.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Green	565		nm	I==20mA
λD [1]	Dominant Wavelength	Super Bright Green	568		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Green	30		nm	IF=20mA
С	Capacitance	Super Bright Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Green	2.2	2.5	V	I=20mA
lR	Reverse Current	Super Bright Green		10	uA	V _R =5V

Notes:

Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Green		
Power dissipation	62.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	140	mA	
Reverse Voltage	5	V	
Operating / Storage Temperature	g / Storage Temperature -40°C To +85°C		

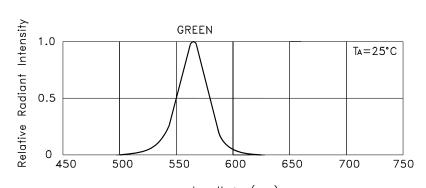
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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^{1.} Luminous intensity/ luminous Flux: +/-15%.

^{1.}Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

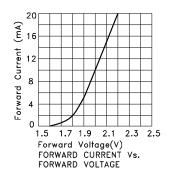


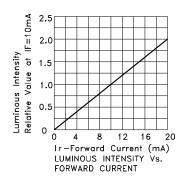
wavelength λ (nm)

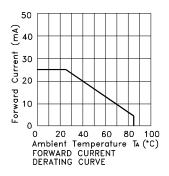
RELATIVE INTENSITY Vs. WAVELENGTH

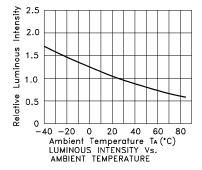
Super Bright Green

ACPSA04-41SGWA



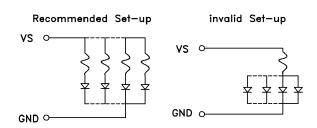






CIRCUIT DESIGN NOTES

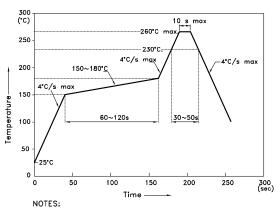
- 1.Protective current—limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



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Reflow Soldering Profile For Lead-free SMT Process.



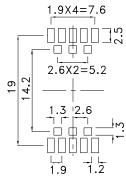
- NOTES:

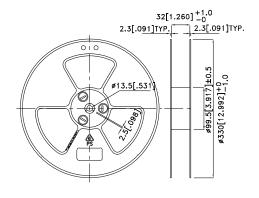
 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

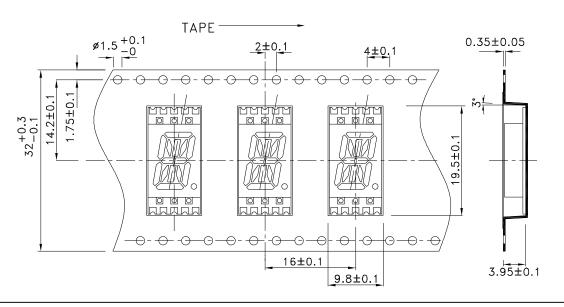
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.15)

Reel Dimension

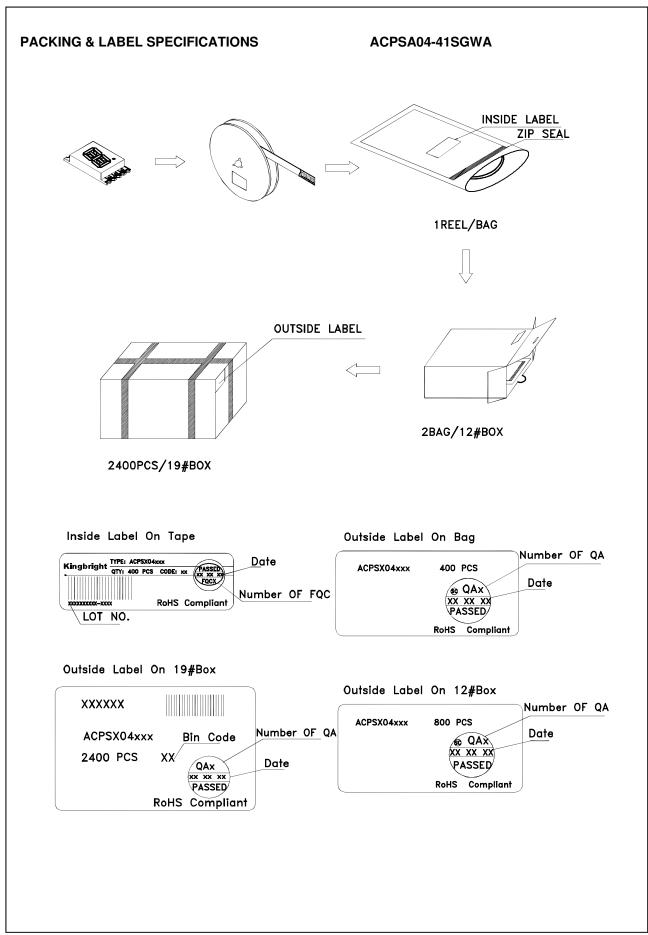




Tape Specifications (Units : mm)



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